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The marking on thisproduct doesn't contain environmental hazardous materials per l'aterial Specification SS-00259 for Sony GP compliant or per directive 2002/95/EC for RoHS compliant.





REVISIONS							
SYM	ECN No.	DATE	APPROVED				
Α	NE-12160	RELEASE REVISION	08/31/2012	Roger Tsai			
В	NE-14134	CHG HOUSING MATERIAL TO HTN	07/16/2014	Roger Tsai			

NOTES:

1. MATERIAL:

HOUSING: HIGH TEMPERATURE THERMAL PLASTIC, HTN,

UL94V-0, COLOR: BLACK.

COVER: HIGH TEMPERATURE THERMAL PLASTIC, NYLON 6T,

UL94V-0, COLOR: BLACK.

TERMINAL: COPPER ALLOY.

2. FINISH:

TERMINAL:

CONTACT AREA: SELECTED GOLD PLATING;

SOLDERING AREA: TIN PLATING 100 μ " THICKNESS MIN. OR G/F; UNDER PLATING: NICKEL PLATING 50 μ " THICKNESS MIN. OVERALL

- 3. PACKING IS PER AMTA PACKING SPECIFICATION PKS-0001.
- 4. THIS PRODUCT DOESN'T CONTAIN ENVIRONMENTAL HAZARDOUS PER DIRECTIVE 2002/95/EC FOR ROHS COMPLIANT.

PART NO. G802MXXX3X5YAEU

NO. OF CIRCUIT — CONTACT FINISH

1: GOLD FLASH OVERALL

2: 15 µ" GOLD

3: 30 µ" GOLD

П	36	22.86	21.59	70	44.45	43.18			
	34	21.59	20.32	68	43.18	41.91			
	32	20.32	19.05	66	41.91	40.64	100	63.50	62.23
	30	19.05	17.78	64	40.64	39.37	98	62.23	60.96
	28	17.78	16.51	62	39.37	38.10	96	60.96	59.69
	26	16.51	15.24	60	38.10	36.83	94	59.69	58.42
	24	15.24	13.97	58	36.83	35.56	92	58.42	57.15
Ε	22	13.97	12.70	56	35.56	34.29	90	57.15	55.88
	20	12.70	11.43	54	34.29	33.02	88	55.88	54.61
	18	11.43	10.16	52	33.02	31.75	86	54.61	53.34
	16	10.16	8.89	50	31.75	30.48	84	53.34	52.07
	14	8.89	7.62	48	30.48	29.21	82	52.07	50.80
	12	7.62	6.35	46	29.21	27.94	80	50.80	49.53
	10	6.35	5.08	44	27.94	26.67	78	49.53	48.26
F	8	5.08	3.81	42	26.67	25.40	76	48.26	46.99
	6	3.81	2.54	40	25.40	24.13	74	46.99	45.72

1.27

38

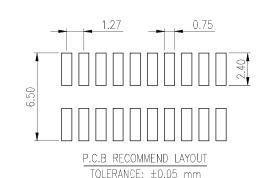
24.13 22.86

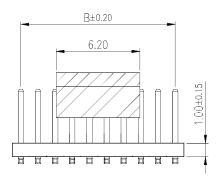
NO. OF CIRCUIT DIM. A DIM. B NO. OF CIRCUIT DIM. A DIM. B NO. OF CIRCUIT DIM. A DIM. B

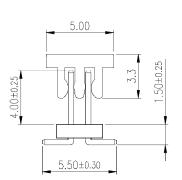
72

45.72 44.45

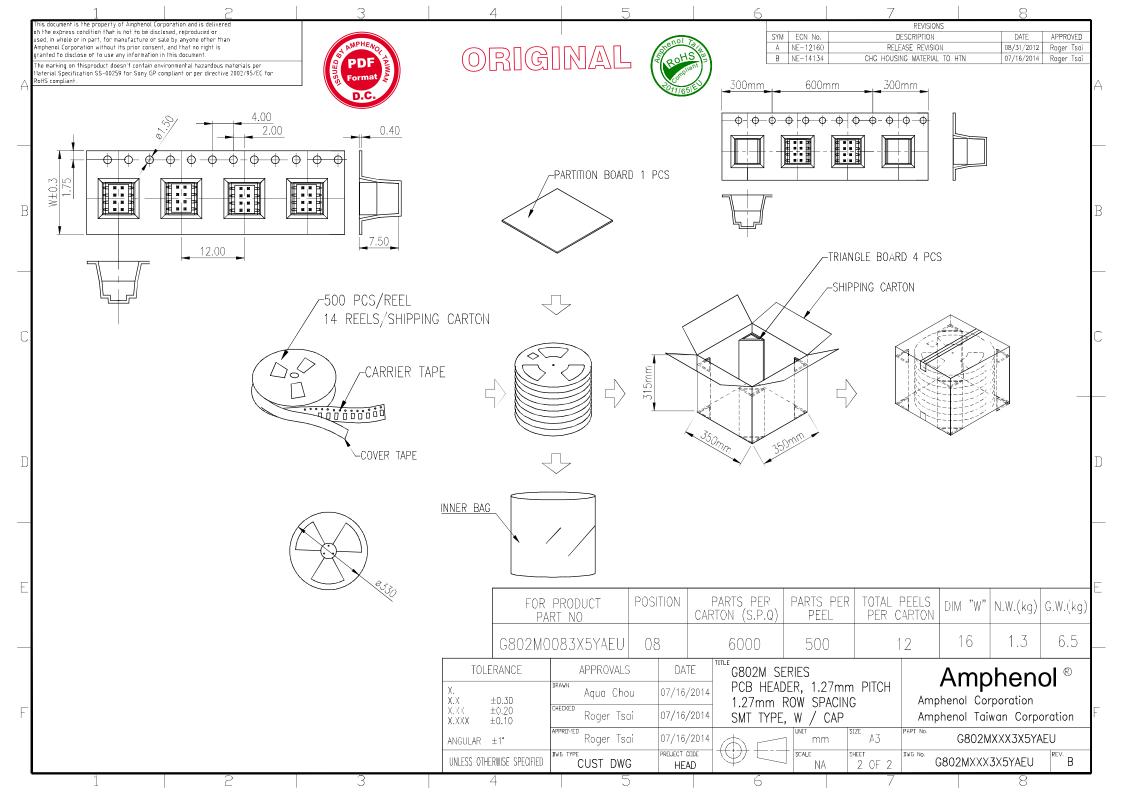
L	A±0.38		_	
1.2		A		0.10
1.2	7			2.40±0.10 2.40±0.10







	TOLERANCE	APPROVALS	DATE	G802M SERIES	Amphenol ®		
	X. X.X ±0.30	Aqua Chou	07/16/2014	PCB HEADER, 1.27mm PITCH 1.27mm ROW SPACING	Amphenol Corporation		
	X.XX ±0.20 X.XXX ±0.10	Roger Tsai	07/16/2014		Amphenol Taiwan Corporation		
	ANGULAR ±1°	Roger Tsai	07/16/2014	UNIT mm SIZE A3	G802MXXX3X5YAEU		
	UNLESS OTHERWISE SPECIFIED	CUST DWG	PROJECT CODE HEAD	SCALE SHEET NA 1 OF 2	G802MXXX3X5YAEU REV. B		
4		5		6 7	8		



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